# **LN2162C13TR**

## Surface Mounting Chip LED

GW Bi-Color Type

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

#### • Rec

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	45	mW	
Forward current	$I_{\mathrm{F}}$	15	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	3	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +80	°C	
Storage temperature	T <sub>stg</sub>	-30 to +85	<b>√°</b> C	

Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

#### • Green

Parameter	Symbol	Rating	Unit
Power dissipation	P <sub>D</sub>	45	mW
Forward current	$I_{F}$	15	mA
Pulse forward current *	$I_{FP}$	60	mA
Reverse voltage	V <sub>R</sub>	4	V
Operating ambient temperature	$T_{ m opr}$	-25 to +80	°C
Storage temperature	T <sub>stg</sub>	-30 to +85	°C

Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

#### ■ Electro-Optical Characteristics T<sub>a</sub> = 25°C

#### • Red

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>		0.65	1.8		mcd
Forward current	CIP CIP			10		mA
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$		2.0	2.8	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$		650		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		40		nm
Reverse current	$I_R$	$V_R = 3 V$			10	μΑ

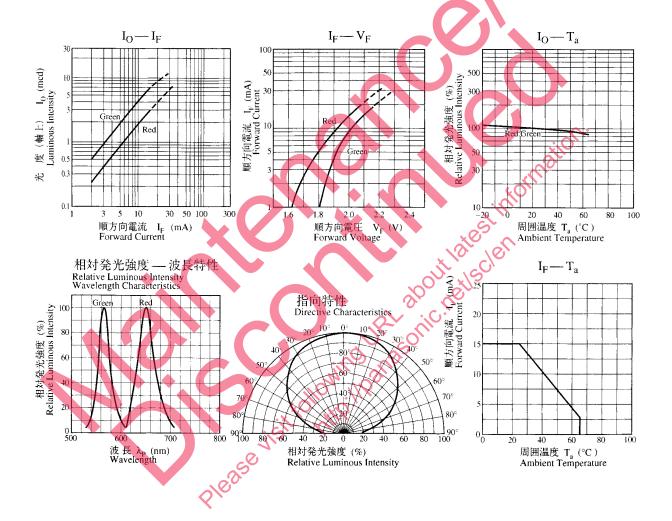
#### ■ Lighting Color / Lens Color

- Red / Clear
- Green / Clear

#### ■ Electro-Optical Characteristics (Continued) $T_a = 25$ °C

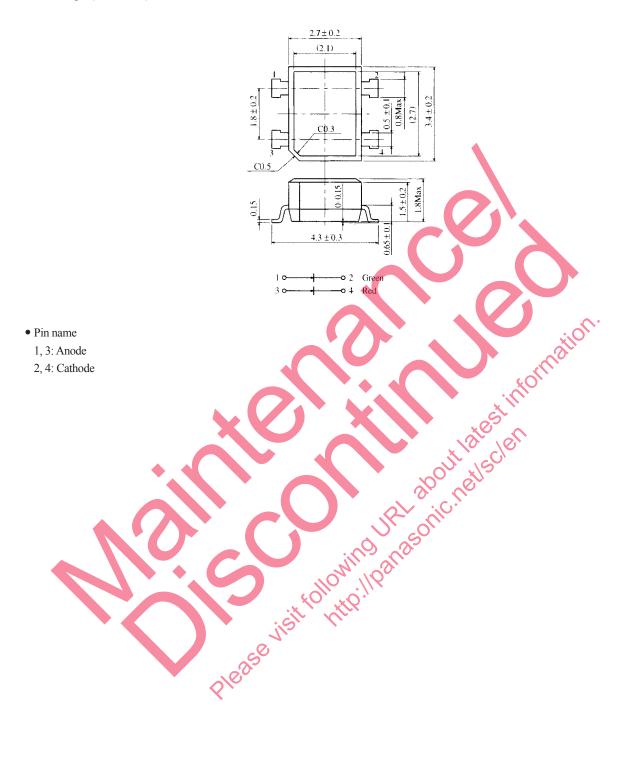
#### • Green

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>		1.5	4.0		mcd
Forward current	$I_{\mathrm{F}}$			10		mA
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$		2.05	2.8	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$		565		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		30		nm
Reverse current	$I_R$	$V_R = 4 V$			10	μΑ



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### ■ Package (Unit: mm)



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